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APPLICATION NO.	FILING DATE	FIRST NAMED INVENTOR	ATTORNEY DOCKET NO.	CONFIRMATION NO.
10/522,059	01/20/2005	Jun Shinozaki	MAT-8640US	1894
23122 RATNERPRE	7590 04/18/2007 STIA		EXAMINER	
PO BOX 980			DHINGRA, RAKESH KUMAR	
VALLEY FOR	RGE, PA 19482-0980		ART UNIT PAPER NUMBER	
· ·			1763	
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SHORTENED STATUTOR	RY PERIOD OF RESPONSE	MAIL DATE	DELIVERY MODE	
3 MC	ONTHS	04/18/2007	PAPER	

Please find below and/or attached an Office communication concerning this application or proceeding.

If NO period for reply is specified above, the maximum statutory period will apply and will expire 6 MONTHS from the mailing date of this communication.

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	Application No.	Applicant(s)
•	10/522,059	SHINOZAKI ET AL.
Office Action Summary	Examiner	Art Unit
	Rakesh K. Dhingra	1763
The MAILING DATE of this communication ap Period for Reply	pears on the cover sheet with the	correspondence address
A SHORTENED STATUTORY PERIOD FOR REPL WHICHEVER IS LONGER, FROM THE MAILING D - Extensions of time may be available under the provisions of 37 CFR 1.1 after SIX (6) MONTHS from the mailing date of this communication. - If NO period for reply is specified above, the maximum statutory period - Failure to reply within the set or extended period for reply will, by statuth Any reply received by the Office later than three months after the mailing earned patent term adjustment. See 37 CFR 1.704(b).	PATE OF THIS COMMUNICATIO 136(a). In no event, however, may a reply be tin will apply and will expire SIX (6) MONTHS from e, cause the application to become ABANDONE	N. nely filed the mailing date of this communication. ED (35 U.S.C. § 133).
Status		
1)⊠ Responsive to communication(s) filed on 20 J	anuary 2005	
	s action is non-final.	
3) Since this application is in condition for allowa closed in accordance with the practice under	ince except for formal matters, pr	
Disposition of Claims		
4) ☐ Claim(s) 1-6 is/are pending in the application. 4a) Of the above claim(s) is/are withdra 5) ☐ Claim(s) is/are allowed. 6) ☐ Claim(s) 1-6 is/are rejected. 7) ☐ Claim(s) is/are objected to. 8) ☐ Claim(s) are subject to restriction and/or		
Application Papers		
9) The specification is objected to by the Examine	er.	
10)⊠ The drawing(s) filed on 20 January 2005 is/are		to by the Examiner.
Applicant may not request that any objection to the	drawing(s) be held in abeyance. Se	e 37 CFR 1.85(a).
Replacement drawing sheet(s) including the correct 11) The oath or declaration is objected to by the E	÷ · ·	
Priority under 35 U.S.C. § 119		
12) Acknowledgment is made of a claim for foreign a) All b) Some * c) None of: 1. Certified copies of the priority documen 2. Certified copies of the priority documen 3. Copies of the certified copies of the priority documen application from the International Burea * See the attached detailed Office action for a list	ts have been received. ts have been received in Applicat ority documents have been receiv ou (PCT Rule 17.2(a)).	ion No ed in this National Stage
Attachment(s) 1) Notice of References Cited (PTO-892)	4) 🔲 Interview Summary	r (PTO-413)
2) Delice of Draftsperson's Patent Drawing Review (PTO-948)	Paper No(s)/Mail D	ate
3) Information Disclosure Statement(s) (PTO/SB/08) Paper No(s)/Mail Date <u>01/05</u> .	5) Notice of Informal I 6) Other:	Patent Application

DETAILED ACTION

Claim Rejections - 35 USC § 103

The following is a quotation of 35 U.S.C. 103(a) which forms the basis for all obviousness rejections set forth in this Office action:

(a) A patent may not be obtained though the invention is not identically disclosed or described as set forth in section 102 of this title, if the differences between the subject matter sought to be patented and the prior art are such that the subject matter as a whole would have been obvious at the time the invention was made to a person having ordinary skill in the art to which said subject matter pertains. Patentability shall not be negatived by the manner in which the invention was made.

This application currently names joint inventors. In considering patentability of the claims under 35 U.S.C. 103(a), the examiner presumes that the subject matter of the various claims was commonly owned at the time any inventions covered therein were made absent any evidence to the contrary.

Applicant is advised of the obligation under 37 CFR 1.56 to point out the inventor and invention dates of each claim that was not commonly owned at the time a later invention was made in order for the examiner to consider the applicability of 35 U.S.C. 103(c) and potential 35 U.S.C. 102(e), (f) or (g) prior art under 35 U.S.C. 103(a).

Claim 4 is rejected under 35 U.S.C. 103(a) as being unpatentable over Yamazaki et al (US PGPUB No. 2002/0011205) in view of Tanaka et al (US PGPUB No. 203/0200928).

Regarding Claim 4: Yamazaki et al teach an apparatus for processing (Figure 1A) display comprising:

A substrate holder 102 for a display, the substrate holder being configured with an edge on which the substrate 103 is supported (like a frame), the substrate being held by its periphery with the frame, and the frame holding the substrate being provided with a protrusion (vertical portion of substrate holder 102

extending to a non-deposition face of the substrate) held in such a way as to surround the substrate 103. Yamazaki et al teach plurality of vapor deposition source 208, but do not teach substrate holder with plurality of frames. It is known in the art to use substrate holder with plurality of frames to enable produce plurality of displays simultaneously as per reference cited hereunder.

Tanaka et al teach an apparatus for deposition of displays (Figure 11) comprising a frame 14 with multiple openings (like plurality of frames) for processing displays. Tanaka et al further teach that in each of frame openings an individual display can be created (paragraphs 0016, 0020-0038).

Therefore it would have been obvious to one of ordinary skill in the art at the time of the invention to use substrate holder with plurality of frames as taught by Tanaka et al et al in the apparatus of Yamazaki et al to enable process plurality of displays simultaneously.

Further, claim limitation reciting a plasma display and deposition are intended use limitations and since the prior art apparatus meets the structural limitations of the claim, the same is considered capable of meeting the intended use limitations.

Claims 1, 4 are rejected under 35 U.S.C. 103(a) as being unpatentable over Kondo et al US Patent No. 6,294,722) in view of Tanaka et al (US PGPUB No. 203/0200928).

Regarding Claims 1, 4: Kondo et al teach an apparatus and method for deposition on substrate for solar battery (Figure 2) comprising:

A substrate holder 1 for a substrate, the substrate holder being configured with a frame with opening 1a, the substrate 2 being held by its periphery with the frame, and the frame holding the substrate being provided with a protrusion (portion of substrate holder 1 extending to a non-deposition face of the substrate 2) held in such a way as to surround the substrate 2. Kondo et al do not teach plurality of frames but it is known in the art to use substrate holder with plurality of frames to enable produce plurality of displays simultaneously as per reference cited hereunder.

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Tanaka et al teach an apparatus for deposition of displays (Figure 11) comprising a frame 14 with multiple openings (like plurality of frames) for processing displays. Tanaka et al further teach that in each of frame openings an individual display can be created (paragraphs 0016, 0020-0038).

Therefore it would have been obvious to one of ordinary skill in the art at the time of the invention to use substrate holder with plurality of frames as taught by Tanaka et al et al in the apparatus of Kondo et al to enable process plurality of displays simultaneously.

Further, claim limitation reciting deposition on plasma display is an intended use limitations and since the prior art apparatus meets the structural limitations of the claim and is used for deposition on similar items that is, solar battery module, the same is considered capable of meeting the intended use limitation, that is deposition on plasma display panels.

Claims 1, 4 are rejected under 35 U.S.C. 103(a) as being unpatentable over Dubs (US Patent No. 5,738,729) in view of Tanaka et al (US PGPUB No. 203/0200928).

Regarding Claim 4: Dubs teaches an apparatus and method for coating (depositing) on a flat substrate (Figures 5, 6) comprising:

A substrate holder for a substrate 3, the substrate holder being configured with a frame 1 with opening, the substrate 3 being held by its periphery with the frame, and the frame holding the substrate being provided with a protrusion (portion of frame 20 extending to a non-deposition face of the substrate 3) held in such a way as to surround the substrate 2. Dubs does not teach plurality of frames but it is known in the art to use substrate holder with plurality of frames to enable produce plurality of displays simultaneously as per reference cited hereunder.

Tanaka et al teach an apparatus for deposition of displays (Figure 11) comprising a frame 14 with multiple openings (like plurality of frames) for processing displays. Tanaka et al further teach that in each of frame openings an individual display can be created (paragraphs 0016, 0020-0038).

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Therefore it would have been obvious to one of ordinary skill in the art at the time of the invention to use substrate holder with plurality of frames as taught by Tanaka et al et al in the apparatus of Kondo et al to enable process plurality of displays simultaneously.

Further, claim limitation reciting a deposition on plasma display is an intended use limitations and since the prior art apparatus meets the structural limitations of the claim and is used for coating on flat substrates, the same is considered capable of meeting the intended use limitation.

Claims 2, 4 are rejected under 35 U.S.C. 103(a) as being unpatentable over Kondo et al US Patent No. 6,294,722) in view of Tanaka et al (US PGPUB No. 203/0200928) as applied to claims 1, 4 and further in view of Patadia et al (US Patent No. 6,146,504).

Regarding Claims 2, 4: Kondo et al in view of Tanaka et al teach all limitations of the claim except height of protrusion.

Patadia et al teach a deposition apparatus (Figure 1, 9) comprising a substrate support 110 for supporting a substrate and a dam 132 (protrusion) is provided around the perimeter of the substrate receiving surface of support to minimize backside deposition on the substrate. Patadia et al further teach that position and dimensions of the dam 132 (protrusion) are optimized to prevent the reaction material reaching backside of substrate (column 7, line 65 to column 8, line 65). Though Patadia et al do not explicitly teach the specific dimension of the protrusion, it would be obvious to optimize the height of protrusion as per process limitations like type of gases, gas flow rate and gas pressure.

Therefore it would have been obvious to one of ordinary skill in the art at the time of the invention to optimize the height of protrusion as taught by Patadia et al in the apparatus of Kondo et al in view of Tanaka et al to minimize backside deposition on the substrate.

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Claims 3, 6 are rejected under 35 U.S.C. 103(a) as being unpatentable over Kondo et al US Patent No. 6,294,722) in view of in view of Tanaka et al (US PGPUB No. 203/0200928) as applied to Claims 1, 4 and further in view of Hiroki et al (US Patent No. 5,374,147).

Regarding Claims 3, 6: Kondo et al in view of Tanaka et al teach all limitations of the claim including substrate holder (frame) 1 for holding substrate, but do not teach holding means including supporting means and positioning means.

Applicant has invoked 35 USC 112, 6th paragraph in respect of claim limitation "the frame comprising holding means including support means for supporting the substrate from underneath and positioning means for positioning the substrate in a planar direction, wherein the substrate is held by fitting the substrate to the positioning means and placing the substrate on the support means", and for which the possible structures disclosed in the specification are described in specification (page 12, line 7 to page 13, line 11 and as per Figures 5-8) and comprise of support means and positioning means for supporting and positioning the substrate.

Hiroki et al teach an apparatus (Figure 12) for supporting a substrate 2 by a stage 73 (frame) and where the stage (frame) comprises holding means including supporting projections 88 (support means) and positioning means (shoes 83, 84 with stoppers 85, 86) for positioning the substrate 2 in a planar direction, wherein the substrate is held by fitting the substrate to the positioning means (83-86) and placing the substrate on the support means 88 (column 10, lines 13-63).

Therefore it would have been obvious to one of ordinary skill in the art at the time of the invention to use frame with support means and positioning means as taught by Hiroki et al in the apparatus of Kondo et al in view of Tanaka et al to ensure correct positioning of the substrate.

Claims 3, 6 are rejected under 35 U.S.C. 103(a) as being unpatentable over Dubs (US Patent No. 5,738,729) in view of Tanaka et al (US PGPUB No. 203/0200928) as applied to Claims 1, 4 and further in view of Hiroki et al (US Patent No. 5,374,147).

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Regarding Claims 3, 6: Dubs in view of Tanaka et al teaches all limitations of the claim including frame 20 for holding substrate, but do not teach holding means including supporting means and positioning means.

Applicant has invoked 35 USC 112, 6th paragraph in respect of claim limitation "the frame comprising holding means including support means for supporting the substrate from underneath and positioning means for positioning the substrate in a planar direction, wherein the substrate is held by fitting the substrate to the positioning means and placing the substrate on the support means", and for which the possible structures disclosed in the specification are described in specification (page 12, line 7 to page 13, line 11 and as per Figures 5-8) and comprise of support means and positioning means for supporting and positioning the substrate.

Hiroki et al teach an apparatus (Figure 12) for supporting a substrate 2 by a stage 73 (frame) and where the stage is comprises holding means including supporting projections 88 (support means) and shoes 83, 84 with stoppers 85, 86 (positioning means) for positioning the substrate 2 in a planar direction, wherein the substrate is held by fitting the substrate to the positioning means (83-86) and placing the substrate on the support means 88 (column 10, lines 13-63).

Therefore it would have been obvious to one of ordinary skill in the art at the time of the invention to use frame with support means and positioning means as taught by Hiroki et al in the apparatus of Dubs in view of Tanaka et al to ensure correct positioning of the substrate.

Conclusion

Any inquiry concerning this communication or earlier communications from the examiner should be directed to Rakesh K. Dhingra whose telephone number is (571)-272-5959. The examiner can normally be reached on 8:30 -6:00 (Monday - Friday).

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If attempts to reach the examiner by telephone are unsuccessful, the examiner's supervisor,

Parviz Hassanzadeh can be reached on (571)-272-1435. The fax phone number for the organization

where this application or proceeding is assigned is 571-273-8300.

Information regarding the status of an application may be obtained from the Patent Application

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Service Representative or access to the automated information system, call 800-786-9199 (IN USA OR

CANADA) or 571-272-1000.

Rakesh Dhingra

Parviz Hassanzadeh

Supervisory Patent Examiner

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